



Description

The SI4932DY-T1-GE3 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = 30V$ $I_D = 10A$

$R_{DS(ON)} < 12m\Omega$ @ $V_{GS}=10V$

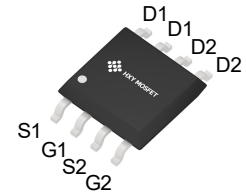
$R_{DS(ON)} < 18m\Omega$ @ $V_{GS}=4.5V$

Application

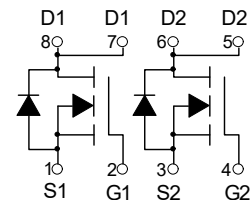
Battery protection

Load switch

Uninterruptible power supply



SOP-8



Dual N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|-----------------|-------|------------|----------|
| SI4932DY-T1-GE3 | SOP-8 | HXY MOSFET | 3000 |

Absolute Maximum Ratings@ $T_J=25^{\circ}C$ (unless otherwise specified)

| Symbol | Parameter | Rating | Units |
|-----------------------|---|------------|---------------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D@T_A=25^{\circ}C$ | Drain Current, V_{GS} @ 4.5V ³ | 10 | A |
| $I_D@T_A=70^{\circ}C$ | Drain Current, V_{GS} @ 4.5V ³ | 8 | A |
| I_{DM} | Pulsed Drain Current ¹ | 55 | A |
| $P_D@T_A=25^{\circ}C$ | Total Power Dissipation | 2 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^{\circ}C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^{\circ}C$ |
| R_{thj-a} | Maximum Thermal Resistance, Junction-ambient ³ | 62.5 | $^{\circ}C/W$ |



Electrical Characteristics Ta = 25°C

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------------|---------------------|--|-----|-----|-----------|------------|
| Drain-Source Breakdown Voltage | V _{DSS} | I _D =250 μ A, V _{GS} =0V | 30 | | | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =30V, V _{GS} =0V | | | 1 | μ A |
| | | V _{DS} =30V, V _{GS} =0V, T _J =55°C | | | 5 | |
| Gate-Body Leakage Current | I _{GSS} | V _{DS} =0V, V _{GS} = \pm 20V | | | \pm 100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250 μ A | 1.5 | | 2.5 | V |
| Static Drain-Source On-Resistance | R _{DS(on)} | V _{GS} =10V, I _D =10A | | | 12 | m Ω |
| | | V _{GS} =10V, I _D =10A T _J =125°C | | | 18 | |
| | | V _{GS} =4.5 V, I _D =8A | | | 16.5 | |
| On State Drain Current | I _{D(ON)} | V _{GS} =10V, V _{DS} =5V | 55 | | | A |
| Forward Transconductance | g _{FS} | V _{DS} =5V, I _D =10A | | 43 | | S |
| Input Capacitance | C _{iss} | V _{GS} =0V, V _{DS} =15V, f=1MHz | 610 | | 910 | pF |
| Output Capacitance | C _{oss} | | 88 | | 160 | |
| Reverse Transfer Capacitance | C _{rss} | | 40 | | 100 | |
| Gate Resistance | R _g | V _{GS} =0V, V _{DS} =0V, f=1MHz | 0.8 | | 2.4 | Ω |
| Total Gate Charge (10V) | Q _g | V _{GS} =10V, V _{DS} =15V, I _D =10A | 11 | | 17 | nC |
| Total Gate Charge (4.5V) | | | 5 | | 8 | |
| Gate Source Charge | Q _{gs} | | | 2.4 | | |
| Gate Drain Charge | Q _{gd} | | | 3 | | |
| Turn-On DelayTime | t _{d(on)} | V _{GS} =10V, V _{DS} =15V, R _L =1.5 Ω , R _{GEN} =3 Ω | | 4.4 | | ns |
| Turn-On Rise Time | t _r | | | 9 | | |
| Turn-Off DelayTime | t _{d(off)} | | | 17 | | |
| Turn-Off Fall Time | t _f | | | 6 | | |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = 10A, di/dt= 500A/us | 5.6 | | 8 | nC |
| Body Diode Reverse Recovery Charge | Q _{rr} | | 6.4 | | 9.6 | |
| Maximum Body-Diode Continuous Current | I _S | | | | 2.5 | A |
| Diode Forward Voltage | V _{SD} | I _S =1A, V _{GS} =0V | | | 1 | V |

Note.The static characteristics in Figures 1 to 6 are obtained using <300us pulses, duty cycle 0.5% max.



Typical Characteristics

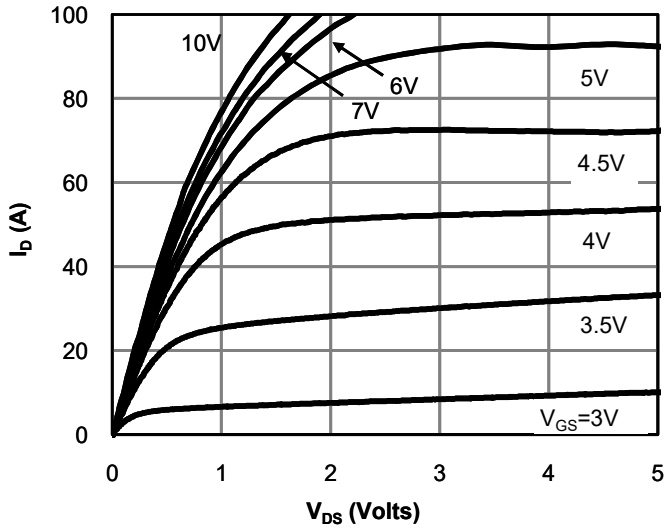


Fig 1: On-Region Characteristics (Note E)

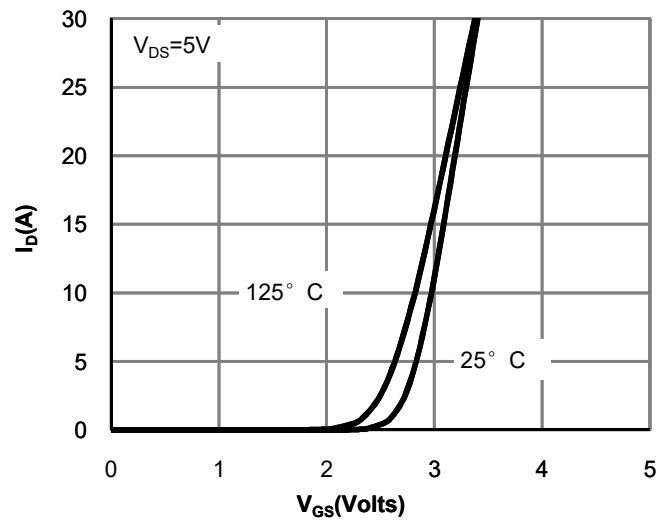


Figure 2: Transfer Characteristics (Note E)

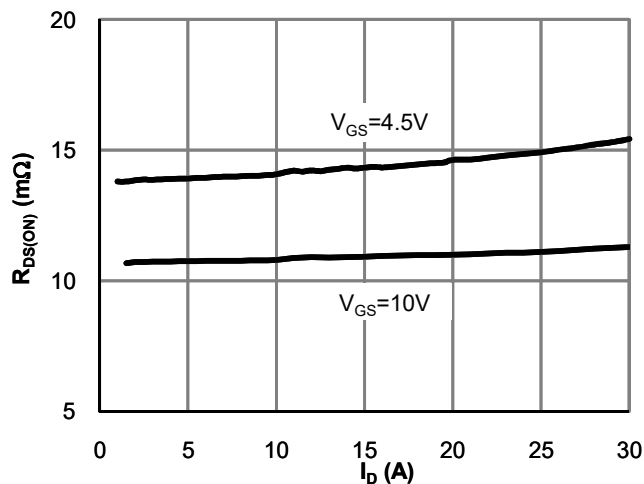


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

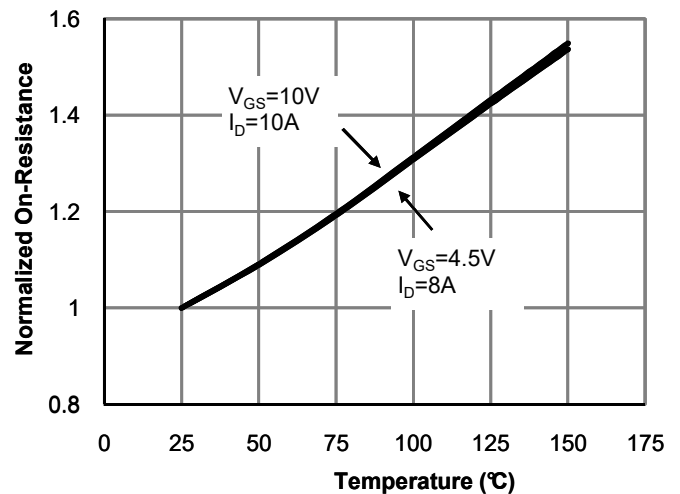


Figure 4: On-Resistance vs. Junction Temperature (Note E)

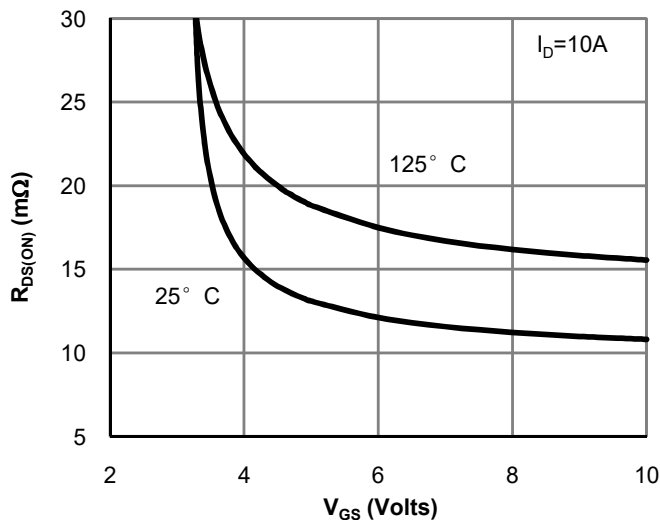


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

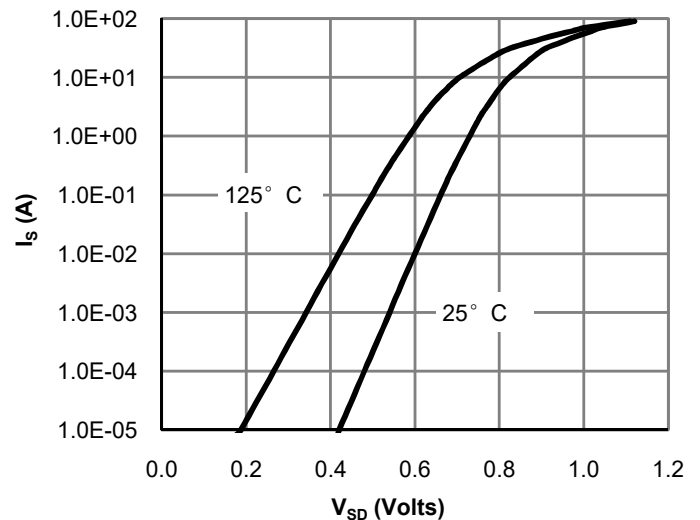


Figure 6: Body-Diode Characteristics (Note E)

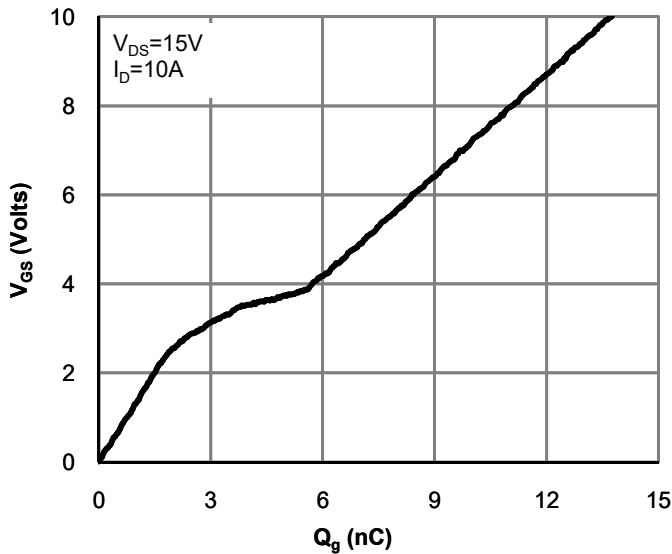


Figure 7: Gate-Charge Characteristics

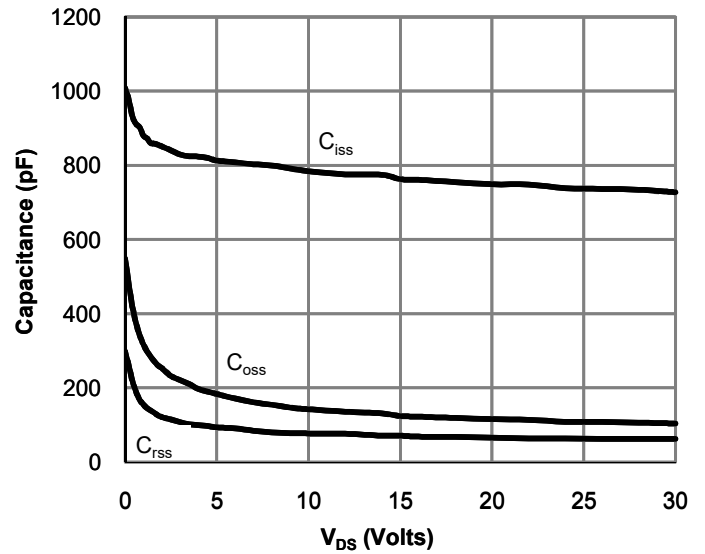


Figure 8: Capacitance Characteristics

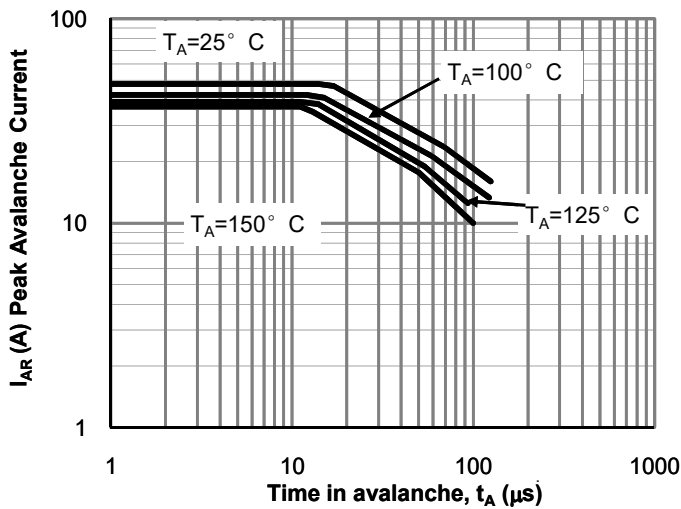


Figure 9: Single Pulse Avalanche capability (Note C)

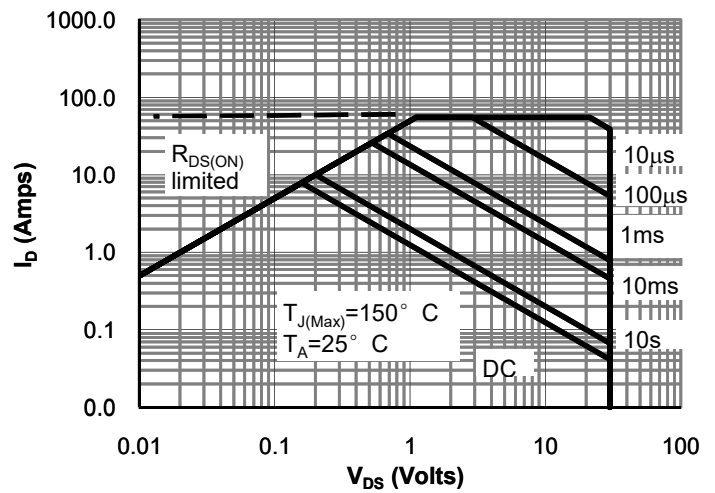


Figure 10: Maximum Forward Biased Safe Operating Area (Note F)

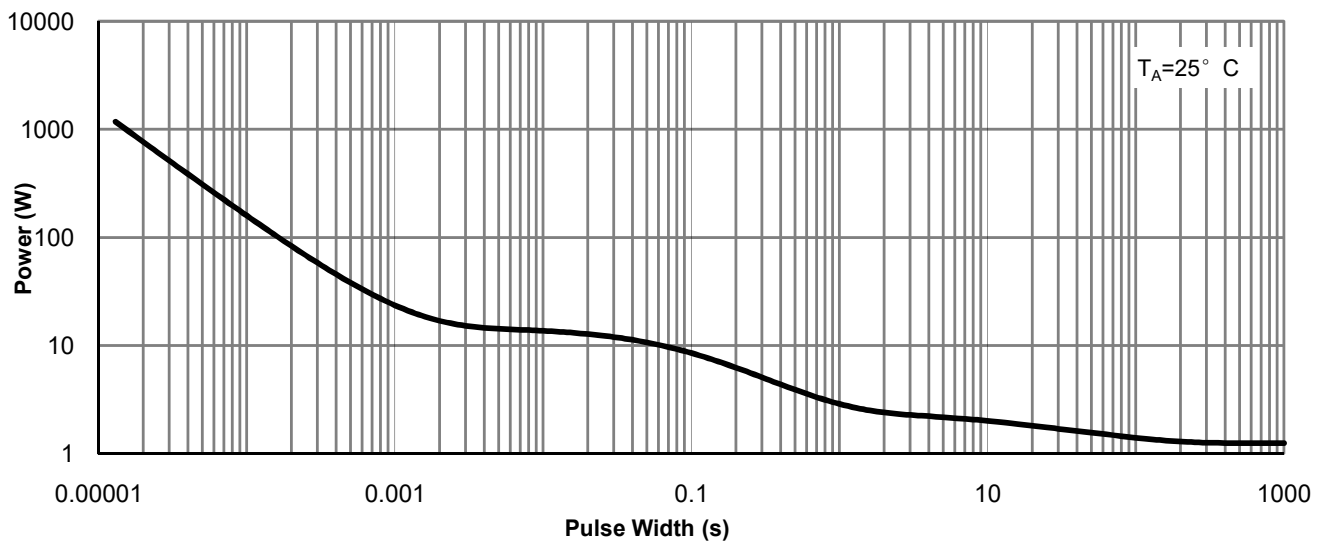


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)

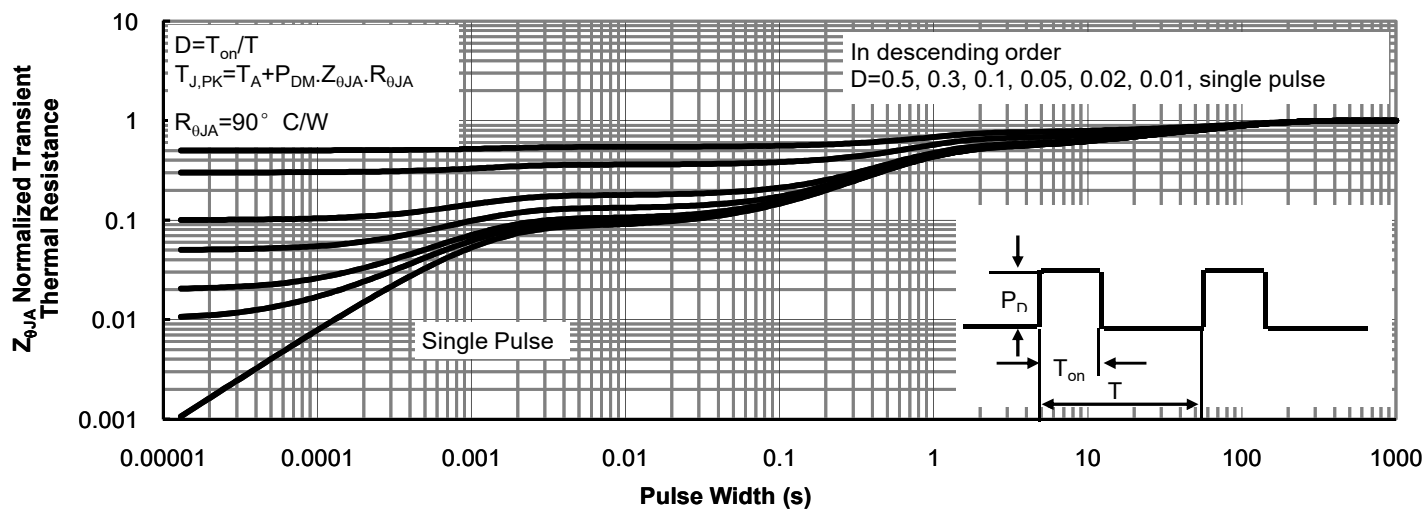
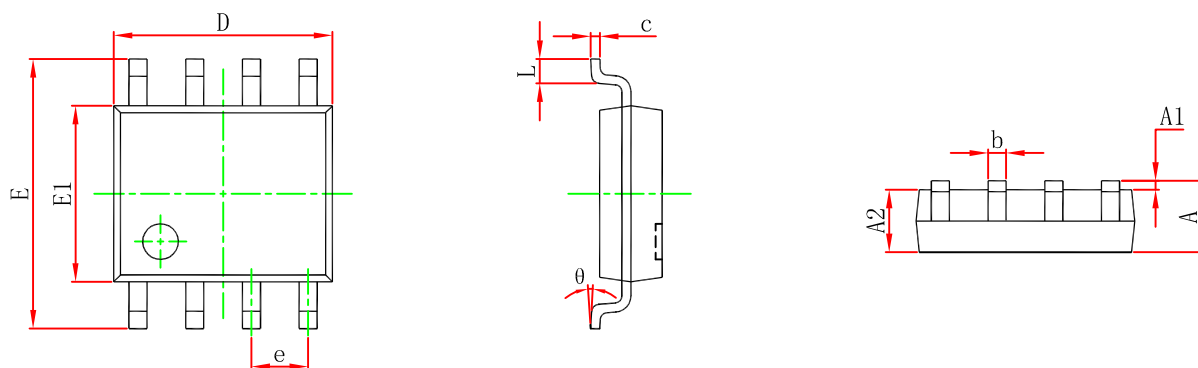


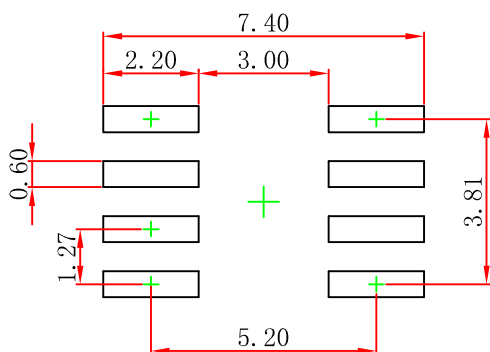
Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)



SOP-8 Package Outline Dimensions



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.007 | 0.010 |
| D | 4.800 | 5.000 | 0.189 | 0.197 |
| e | 1.270 (BSC) | | 0.050 (BSC) | |
| E | 5.800 | 6.200 | 0.228 | 0.244 |
| E1 | 3.800 | 4.000 | 0.150 | 0.157 |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



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